

# GaAs INTEGRATED CIRCUIT UPG2311T5F

### GaAs MMIC LOW NOISE AMPLIFIER FOR GPS

### **DESCRIPTION**

The  $\mu$ PG2311T5F is a GaAs MMIC LNA for Car Navigation Systems and Handy GPS. This IC consists of two stage amplifiers and has high gain performance.

### **FEATURES**

High gain : G<sub>P</sub> = 37 dB TYP.
 Low noise : NF = 1.2 dB TYP.

• 12-pin plastic QFN package (3.0 × 3.0 × 0.75 mm)

#### **APPLICATION**

- · Car Navigation System
- · Handy GPS

### **★ ORDERING INFORMATION (Pb-Free)**

Part Number	Order Number	Package	Marking	Supplying Form
μ <b>PG231</b> 1T5F-E2-A	μPG2311T5F-E2-A	12-pin plastic QFN (Pb-Free)	2311	Embossed tape 8 mm wide     Pin 1 indicates roll-in direction of tape
				Qty 3 kpcs/reel

Remark To order evaluation samples, contact your nearby sales office.

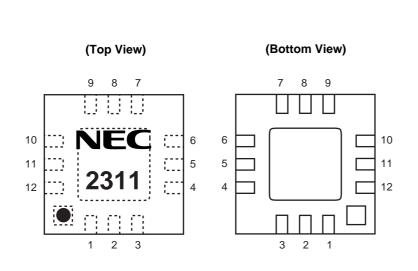
Part number for sample order: UPG2311T5F-A

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

### **★ PIN CONNECTIONS**



Pin No.	Pin Name
1	OUT2
2	GND
3	Vcc2
4	Vcc1
5	GND
6	IN1
7	GND
8	OUT1
9	GND
10	IN2
11	GND
12	GND
EXPOSED PAD	GND

## ABSOLUTE MAXIMUM RATINGS (TA = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Supply Voltage	Vcc1, Vcc2	+5.0	V
Input Power	Pin	-25	dBm
Total Power Dissipation	Ptot	0.25 Note	W
Operating Ambient Temperature	TA	-45 to +85	°C
Storage Temperature	T <sub>stg</sub>	–55 to +150	°C

**Note** Mounted on double-sided copper-clad  $50 \times 50 \times 1.6$  mm epoxy glass PWB, TA = +85°C

### RECOMMENDED OPERATING RANGE

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency	f <sub>opt</sub>	_	1.575	-	GHz
Supply Voltage	Vcc1, Vcc2	+2.7	+3.0	+3.3	V

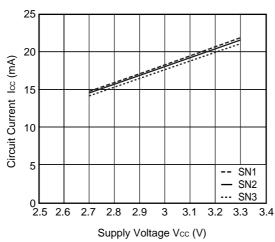
# ELECTRICAL CHARACTERISTICS (TA = +25°C, Vcc1 = Vcc2 = +3.0 V, Zo = 50 $\Omega$ , unless otherwise specified)

	Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
	Power Gain Note 1	G₽	f = 1.575 GHz	34	37	-	dB
	Noise Figure Note 2	NF	f = 1.575 GHz	1	1.2	1.5	dB
	Input Return Loss	RLin	f = 1.575 GHz	1	5	1	dB
r	Output Return Loss	RLout	f = 1.575 GHz	1	20	1	dB
	1 dB Gain Compression Output Power	Po (1 dB)	f = 1.575 GHz	I	+5	I	dBm
	Circuit Current Note 3	lcc	f = 1.575 GHz, Non-RF	-	17	20	mA

Notes 1. Total gain of 1st stage and 2nd stage amplifiers (not include filter loss).

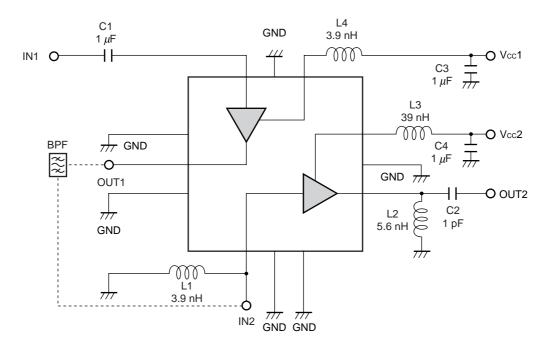
- 2. NF of 1st stage amplifier.
- 3. Please refer to following chart.

### CIRCUIT CURRENT vs. SUPPLY VOLTAGE



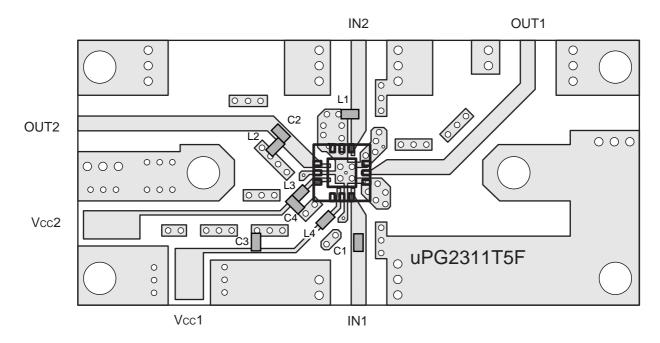
**Remark** The graph indicates nominal characteristics.

### **★ TEST CIRCUIT**



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

### **★ ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD**

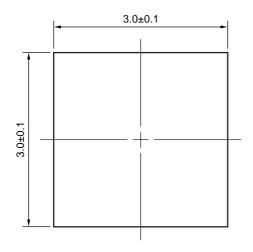


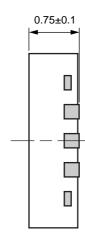
### **\* USING THE NEC EVALUATION BOARD**

Symbol	Rating	Size	Symbol	Rating	Size
C1	1 <i>μ</i> F	1608	L1	3.9 nH	1005
C2	1 pF	1005	L2	5.6 nH	1005
С3	1 <i>μ</i> F	1608	L3	39 nH	1005
C4	1 <i>μ</i> F	1608	L4	3.9 nH	1005

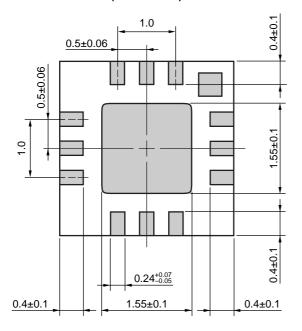
## **★ PACKAGE DIMENSIONS**

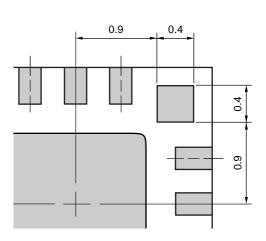
# 12-PIN PLASTIC QFN (UNIT: mm)





### (Bottom View)





Dimensions of pin No.1 indication

# RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).



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Subject: Compliance with EU Directives

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CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (\*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices		
Lead (Pb)	< 1000 PPM	-A -AZ Not Detected (*)		
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
PBB	< 1000 PPM	Not Detected		
PBDE	< 1000 PPM	Not Detected		

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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